PCIe Gen 2 main Clock for Intel-based Servers

Recommended Application:

PCIe Gen 2 & FBD compliant CK410B/CK410B+ clock for Intel-based servers

Output Features:

- 5 - 0.7V current-mode differential CPU pairs
- 4 - 0.7V current-mode differential SRC pair
- 4 - PCI (33MHz)
- 3 - PCICLK_F, (33MHz) free-running
- 1 - 48MHz
- 2 - REF, 14.318MHz

Key Specifications:

- CPU cycle-cycle jitter: < 50ps
- SRC cycle-cycle jitter: < 125ps
- PCI cycle-cycle jitter: < 500ps
- CPU output skew: < 100ps
- SRC output skew: < 250ps
- ± 300ppm frequency accuracy on all outputs except 48MHz
- ± 100ppm frequency accuracy on 48MHz

Features/Benefits:

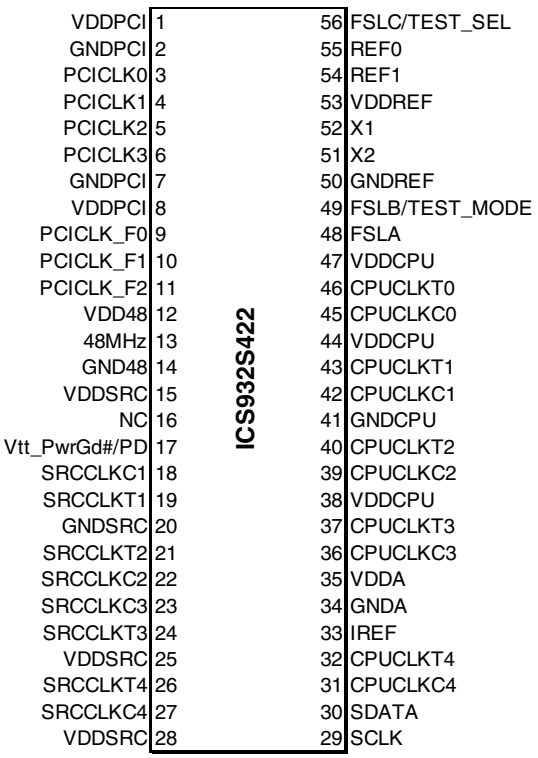
- Supports spread spectrum modulation, 0 to -0.5% down spread
- Uses external 14.318MHz crystal and external load capacitors for low ppm synthesis error
- CPU clocks independent of SRC/PCI clocks
- D2/D3 SMBus address
- Compliant with PCIe Gen II phase noise specifications

Functionality

FSLC[1]	FSLB[1]	FSLA[2]	CPU MHz	SRC MHz	PCI MHz	REF MHz	USB MHz
0	0	0	266.67	100.00	33.33	14.318	48.000
0	0	1	133.33	100.00	33.33	14.318	48.000
0	1	0	200.00	100.00	33.33	14.318	48.000
0	1	1	166.67	100.00	33.33	14.318	48.000
1	0	0	333.33	100.00	33.33	14.318	48.000
1	0	1	100.00	100.00	33.33	14.318	48.000
1	1	0	400.00	100.00	33.33	14.318	48.000
1	1	1	Reserved				

1. FSLB and FSLC are three-level inputs. Please see VIL_FS and VIH_FS specifications in the Input/Supply/Common Output Parameters Table for correct values. Also refer to the Test Clarification Table.
2.FSLA is a low-threshold input. Please see the VIL_FS and VIH_FS specifications in the Input/Supply/Common Output Parameters Table for correct values.

Pin Configuration



56-pin SSOP & TSSOP

1412A—12/10/07

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Pin Description

Pin #	PIN NAME	PIN TYPE	DESCRIPTION
1	VDDPCI	PWR	Power supply for PCI clocks, nominal 3.3V
2	GNDPCI	PWR	Ground pin for the PCI outputs
3	PCICLK0	OUT	PCI clock output.
4	PCICLK1	OUT	PCI clock output.
5	PCICLK2	OUT	PCI clock output.
6	PCICLK3	OUT	PCI clock output.
7	GNDPCI	PWR	Ground pin for the PCI outputs
8	VDDPCI	PWR	Power supply for PCI clocks, nominal 3.3V
9	PCICLK_F0	OUT	Free running PCI clock not affected by PCI_STOP# .
10	PCICLK_F1	OUT	Free running PCI clock not affected by PCI_STOP# .
11	PCICLK_F2	OUT	Free running PCI clock not affected by PCI_STOP# .
12	VDD48	PWR	Power pin for the 48MHz output.3.3V
13	48MHz	OUT	48MHz clock output.
14	GND48	PWR	Ground pin for the 48MHz outputs
15	VDDSRC	PWR	Supply for SRC clocks, 3.3V nominal
16	NC	N/A	No Connection.
17	Vtt_PwrGd#/PD	IN	Vtt_PwrGd# is an active low input used to determine when latched inputs are ready to be sampled. PD is an asynchronous active high input pin used to put the device into a low power state. The internal clocks, PLLs and the crystal oscillator are stopped.
18	SRCCLKC1	OUT	Complement clock of differential push-pull SRC clock pair.
19	SRCCLKT1	OUT	True clock of differential SRC clock pair.
20	GNDSRC	PWR	Ground pin for the SRC outputs
21	SRCCLKT2	OUT	True clock of differential SRC clock pair.
22	SRCCLKC2	OUT	Complement clock of differential SRC clock pair.
23	SRCCLKC3	OUT	Complement clock of differential SRC clock pair.
24	SRCCLKT3	OUT	True clock of differential SRC clock pair.
25	VDDSRC	PWR	Supply for SRC clocks, 3.3V nominal
26	SRCCLKT4	OUT	True clock of differential SRC clock pair.
27	SRCCLKC4	OUT	Complement clock of differential SRC clock pair.
28	VDDSRC	PWR	Supply for SRC clocks, 3.3V nominal

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Pin Description (Continued)

Pin #	PIN NAME	Type	Pin Description
29	SCLK	IN	Clock pin of SMBus circuitry, 5V tolerant.
30	SDATA	I/O	Data pin for SMBus circuitry, 3.3V tolerant.
31	CPUCLKC4	OUT	Complementary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
32	CPUCLKT4	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
33	IREF	OUT	This pin establishes the reference current for the differential current-mode output pairs. This pin requires a fixed precision resistor tied to ground in order to establish the appropriate current. 475 ohms is the standard value.
34	GNDA	PWR	Ground pin for the PLL core.
35	VDDA	PWR	3.3V power for the PLL core.
36	CPUCLKC3	OUT	Complementary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
37	CPUCLKT3	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
38	VDDCPU	PWR	Supply for CPU clocks, 3.3V nominal
39	CPUCLKC2	OUT	Complementary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
40	CPUCLKT2	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
41	GNDCPU	PWR	Ground pin for the CPU outputs
42	CPUCLKC1	OUT	Complementary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
43	CPUCLKT1	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
44	VDDCPU	PWR	Supply for CPU clocks, 3.3V nominal
45	CPUCLKC0	OUT	Complementary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
46	CPUCLKT0	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
47	VDDCPU	PWR	Supply for CPU clocks, 3.3V nominal
48	FSLA	IN	3.3V tolerant input for CPU frequency selection. Refer to input electrical characteristics for Vil_FS and Vih_FS values.
49	FSLB/TEST_MODE	IN	3.3V tolerant input for CPU frequency selection. Refer to input electrical characteristics for Vil_FS and Vih_FS values. TEST_MODE is a real time input to select between Hi-Z and REF/N divider mode while in test mode. Refer to Test Clarification Table.
50	GNDREF	PWR	Ground pin for the REF outputs.
51	X2	OUT	Crystal output, Nominally 14.318MHz
52	X1	IN	Crystal input, Nominally 14.318MHz.
53	VDDREF	PWR	Ref, XTAL power supply, nominal 3.3V
54	REF1	OUT	14.318 MHz reference clock.
55	REF0	OUT	14.318 MHz reference clock.
56	FSLC/TEST_SEL	IN	3.3V tolerant input for CPU frequency selection. Low voltage threshold inputs, see input electrical characteristics for Vil_FS and Vih_FS values. TEST_Sel: 3-level latched input to enable test mode. Refer to Test Clarification Table

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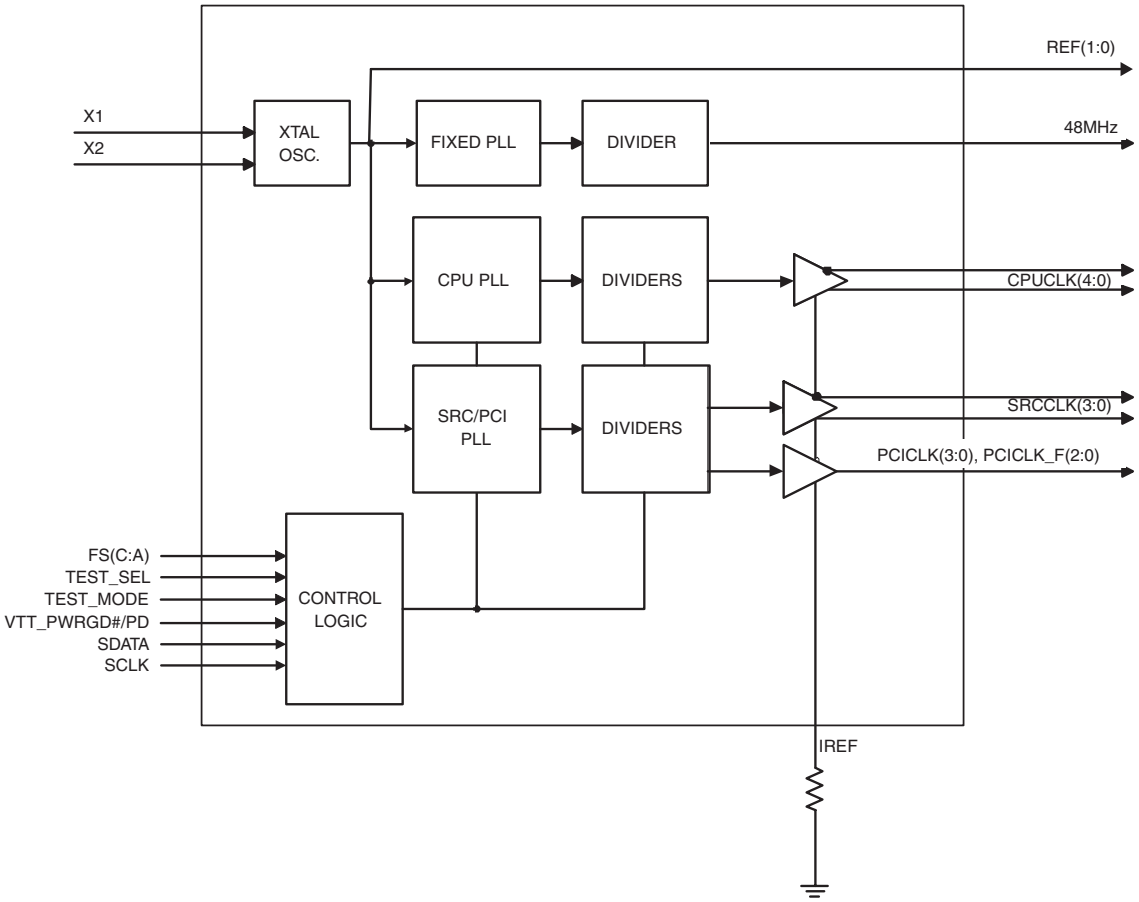
General Description

The **ICS932S422C** is a main clock synthesizer for CK410-generation Intel server platforms. The **ICS932S422C** is driven with a 14.318MHz crystal. It generates 5 CPU output pairs up to 400MHz and PCI-Express clocks at 100 or 200 MHz. The 48 MHz USB clock is an exact 48.000 MHz clock.

Block Diagram



Power Groups

Pin Number		Description
VDD	GND	
53	50	Xtal, Ref
1,8	2,7	PCICLK outputs
15,25,28	20	SRCCLK outputs
35	34	Master clock, CPU Analog
12	14	48MHz, PLL_48
47,44,38	41	CPUCLK clocks

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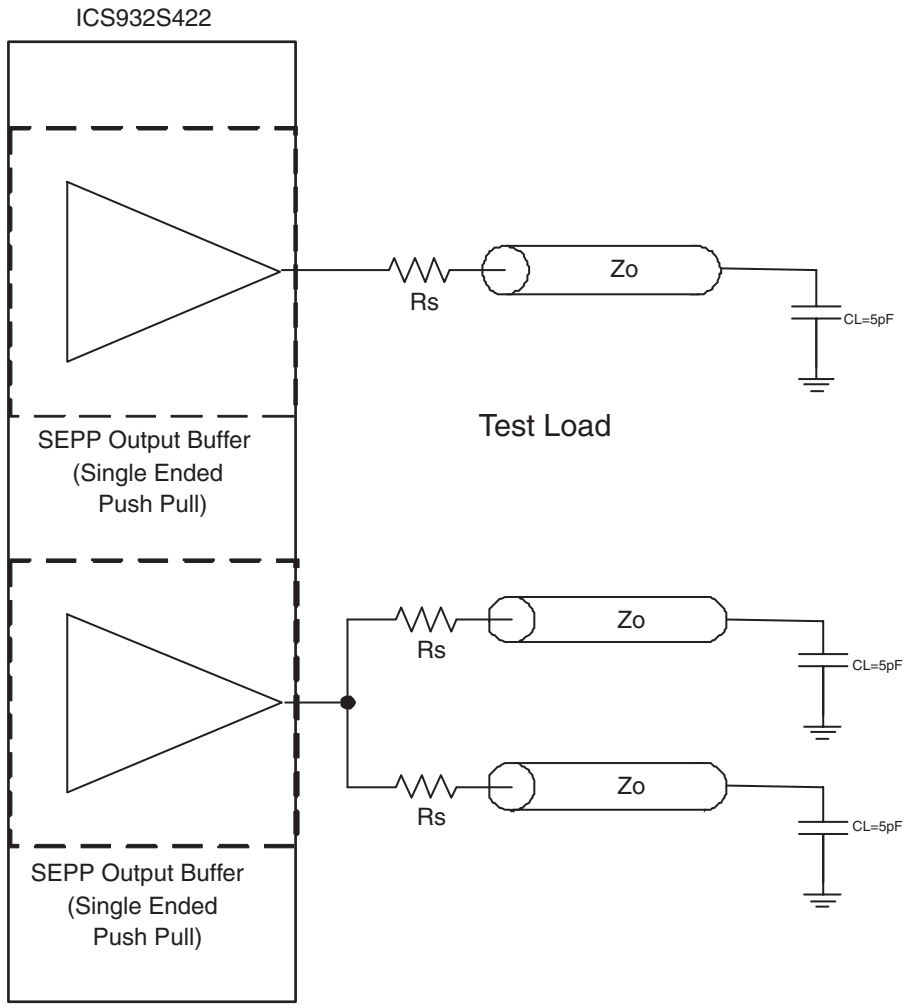
Single-ended Output Terminations



The singled-ended outputs of the ICS 932S422 default to a drive strength of 2 loads. The REF clocks can be turned down to 1-load strength via the SMBus. Suggested termination resistors are as follows for transmission lines with Zo = 50 ohms:

Single-ended outputs at 2-load strength (Power up default for all single-ended outputs)	Driving 1 load, Rs = 33 ohms
	Driving 2 loads, Rs = 7.5 ohms
Single-ended outputs at 1-load strength (REF clock only)	Driving 1 load, Rs = 22 ohms

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Absolute Maximum Rating

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
3.3V Core Supply Voltage	VDD_A	-			V_{DD} + 0.5V	V	1
3.3V Logic Input Supply Voltage	VDD_In	-	GND - 0.5		V_{DD} + 0.5V	V	1
Storage Temperature	Ts	-	-65		150	˚C	1
Ambient Operating Temp	Tambient	-	0		70	°C	1
Case Temperature	Tcase	-			115	°C	1
Input ESD protection HBM	ESD prot	-	2000			V	1

[1]Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics - Input/Supply/Common Output Parameters

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	Notes
Input High Voltage	V_{IH}	3.3 V +/-5%	2		V_{DD} + 0.3	V	1
Input Low Voltage	V_{IL}	3.3 V +/-5%	V_{SS} - 0.3		0.8	V	1
Input High Current	I_{IH}	$V_{IN} = V_{DD}$	-5		5	uA	1
Input Low Current	I_{IL1}	V_{IN} = 0 V; Inputs with no pull-up resistors	-5			uA	1
	I_{IL2}	V_{IN} = 0 V; Inputs with pull-up resistors	-200			uA	1
Low Threshold Input-High Voltage	V_{IH_FS}	3.3 V +/-5%	0.7		V_{DD} + 0.3	V	1
Low Threshold Input-Low Voltage	V_{IL_FS}	3.3 V +/-5%	V_{SS} - 0.3		0.35	V	1
Operating Supply Current	$I_{DD3.3OP}$	Full Active, C_L = Full load;			350	mA	1
Operating Current	$I_{DD3.3OP}$	all outputs driven			400	mA	1
Powerdown Current	$I_{DD3.3PD}$	all diff pairs driven			70	mA	1
		all differential pairs tri-stated			12	mA	1
Input Frequency	F_i	V_{DD} = 3.3 V		14.31818		MHz	2
Pin Inductance	L_{pin}				7	nH	1
Input Capacitance	C_{IN}	Logic Inputs			5	pF	1
	C_{OUT}	Output pin capacitance			6	pF	1
	C_{INX}	X1 & X2 pins			5	pF	1
Clk Stabilization	T_{STAB}	From VDD Power-Up or de-assertion of PD to 1st clock			1.8	ms	1
Modulation Frequency		Triangular Modulation	30		33	kHz	1
Tdrive_PD		CPU output enable after PD de-assertion			300	us	1
Tfall_PD		PD fall time of			5	ns	1
Trise_PD		PD rise time of			5	ns	1
SMBus Voltage	V_{DD}		2.7		5.5	V	1
Low-level Output Voltage	V_{OL}	@ I_{PULLUP}			0.4	V	1
Current sinking at V_{OL} = 0.4 V	I_{PULLUP}		4			mA	1
SCLK/SDATA Clock/Data Rise Time	T_{RI2C}	(Max VIL - 0.15) to (Min VIH + 0.15)			1000	ns	1
SCLK/SDATA Clock/Data Fall Time	T_{FI2C}	(Min VIH + 0.15) to (Max VIL - 0.15)			300	ns	1

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%

[1]Guaranteed by design and characterization, not 100% tested in production.

[2] Input frequency should be measured at the REF pin and tuned to ideal 14.31818MHz to meet ppm frequency accuracy on PLL outputs.

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Electrical Characteristics - CPU 0.7V Current Mode Differential Pair

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	NOTES
Current Source Output Impedance	Zo	$V_O = V_x$	3000			Ω	1
Voltage High	VHigh	Statistical measurement on single ended signal	660		850	mV	1,3
Voltage Low	VLow		-150		150	mV	1,3
Max Voltage	Vovs	Measurement on single ended signal using absolute value.			1150	mV	1
Min Voltage	Vuds		-300			mV	1
Crossing Voltage (abs)	Vx(abs)		250		550	mV	1
Crossing Voltage (var)	d-Vx	Variation of crossing over all edges			140	mV	1
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
Average period	Tperiod	400MHz nominal	2.4993		2.5008	ns	2
		400MHz spread	2.4993		2.5133	ns	2
		333.33MHz nominal	2.9991		3.0009	ns	2
		333.33MHz spread	2.9991		3.016	ns	2
		266.66MHz nominal	3.7489		3.7511	ns	2
		266.66MHz spread	3.7489		3.77	ns	2
		200MHz nominal	4.9985		5.0015	ns	2
		200MHz spread	4.9985		5.0266	ns	2
		166.66MHz nominal	5.9982		6.0018	ns	2
		166.66MHz spread	5.9982		6.0320	ns	2
		133.33MHz nominal	7.4978		7.5023	ns	2
		133.33MHz spread	7.4978		7.5400	ns	2
		100.00MHz nominal	9.9970		10.0030	ns	2
		100.00MHz spread	9.9970		10.0533	ns	2
Absolute min period	T_{absmin}	400MHz nominal/spread	2.4143			ns	1,2
		333.33MHz nominal/spread	2.9141			ns	1,2
		266.66MHz nominal/spread	3.6639			ns	1,2
		200MHz nominal/spread	4.8735			ns	1,2
		166.66MHz nominal/spread	5.8732			ns	1,2
		133.33MHz nominal/spread	7.3728			ns	1,2
		100.00MHz nominal/spread	9.8720			ns	1,2
Rise Time	t_r	V_{OL} = 0.175V, V_{OH} = 0.525V	175		525	ps	1
Fall Time	t_f	V_{OH} = 0.525V V_{OL} = 0.175V	175		525	ps	1
Rise Time Variation	d-t_r	V_{OL} = 0.175V, V_{OH} = 0.525V			125	ps	1
Fall Time Variation	d-t_f	V_{OH} = 0.525V V_{OL} = 0.175V			125	ps	1
Duty Cycle	d_{t3}	Measurement from differential wavefrom	45		55	%	1
Skew	t_{sk3}	CPU(4:0), V_T = 50%			100	ps	1
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	Measurement from differential wavefrom, (CPU(4:0))			50	ps	1

*T_A = 0 - 70°C; V_{DD} = 3.3 V +/-5%; C_L =2pF, R_S=33.2Ω, R_P=49.9Ω, I_{REF} = 475Ω

[1]Guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF is at 14.31818MHz

[3]$I_{REF} = V_{DD}/(3xR_R)$. For R_R = 475Ω (1%), I_{REF} = 2.32mA. I_{OH} = 6 x I_{REF} and V_{OH} = 0.7V @ Z_O=50Ω.

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Electrical Characteristics - SRC/SATA 0.7V Current Mode Differential Pair

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	Notes
Current Source Output Impedance	Zo	$V_O = V_x$	3000			Ω	1
Voltage High	VHigh	Statistical measurement on single ended signal	660		850	mV	1,3
Voltage Low	VLow		-150		150	mV	1,3
Max Voltage	Vovs	Measurement on single ended signal using absolute value.			1150	mV	1
Min Voltage	Vuds		-300			mV	1
Crossing Voltage (abs)	Vx(abs)		250		550	mV	1
Crossing Voltage (var)	d-Vx	Variation of crossing over all edges			140	mV	1
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
Average period	Tperiod	100.00MHz nominal	9.9970		10.0030	ns	2
		100.00MHz spread	9.9970		10.0533	ns	2
Absolute min period	Tabsmin	100.00MHz nominal/spread	9.8720			ns	1,2
Rise Time	t_r	V_{OL} = 0.175V, V_{OH} = 0.525V	175		525	ps	1
Fall Time	t_f	V_{OH} = 0.525V V_{OL} = 0.175V	175		525	ps	1
Rise Time Variation	d-t_r	V_{OL} = 0.175V, V_{OH} = 0.525V			125	ps	1
Fall Time Variation	d-t_f	V_{OH} = 0.525V V_{OL} = 0.175V			125	ps	1
Duty Cycle	d_{t3}	Measurement from differential wavefrom	45		55	%	1
Skew	t_{sk3}	V_T = 50%			250	ps	1
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	Measurement from differential wavefrom			125	ps	1

*T_A = 0 - 70°C; V_{DD} = 3.3 V +/-5%; C_L =2pF, R_S=33.2Ω, R_P=49.9Ω, I_{REF} = 475Ω

[1]Guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF is at 14.31818MHz

[3]$I_{REF} = V_{DD}/(3xR_R)$. For R_R = 475Ω (1%), I_{REF} = 2.32mA. I_{OH} = 6 x I_{REF} and V_{OH} = 0.7V @ Z_O=50Ω.

Electrical Characteristics - PCICLK/PCICLK_F

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	NOTES
Output Impedance	R_{DSP}	$V_O = V_{DD}$*(0.5)	12		55	Ω	1
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4			V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA			0.55	V	1
Output High Current	I_{OH}	V_{OH} @MIN = 1.0 V	-33			mA	1
		V_{OH}@MAX = 3.135 V			-33	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	30			mA	1
		V_{OL} @ MAX = 0.4 V			38	mA	1
Rise Time	t_r	V_{OL} = 0.4 V, V_{OH} = 2.4 V	0.5		2	ns	1
Fall Time	t_f	V_{OH} = 2.4 V, V_{OL} = 0.4 V	0.5		2	ns	1
Duty Cycle	d_{t1}	V_T = 1.5 V	45		55	%	1
Group Skew	t_{skew}	V_T = 1.5 V			250	ps	1
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	V_T = 1.5 V			500	ps	1

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 22Ω (unless otherwise specified)

[1]Guaranteed by design and characterization, not 100% tested in production.

[3] Spread Spectrum is off

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Electrical Characteristics - USB48MHz

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	NOTES
Long Accuracy	ppm	see Tperiod min-max values	-100		100	ppm	1,2
Clock period	T_{period}	48.00MHz output nominal	20.8313		20.8354	ns	2
Output Impedance	R_{DSP}	$V_O = V_{DD}*(0.5)$	12		55	Ω	1
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4			V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA			0.55	V	1
Output High Current	I_{OH}	V_{OH} @MIN = 1.0 V	-29			mA	1
		V_{OH}@MAX = 3.135 V			-33	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	29			mA	1
		V_{OL} @ MAX = 0.4 V			27	mA	1
Rise Time	t_{r_USB}	V_{OL} = 0.4 V, V_{OH} = 2.4 V	1		2	ns	1
Fall Time	t_{f_USB}	V_{OH} = 2.4 V, V_{OL} = 0.4 V	1		2	ns	1
Duty Cycle	d_{t1}	V_T = 1.5 V	45		55	%	1
Group Skew	t_{skew}	V_T = 1.5 V			250	ps	1
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	V_T = 1.5 V			500	ps	1

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 22Ω

[1]Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics - REF-14.318MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
Clock period	T_{period}	14.318MHz output nominal	69.8270		69.8550	ns	2
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4			V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA			0.4	V	1
Output High Current	I_{OH}	V_{OH} @MIN = 1.0 V	-33			mA	1
		V_{OH}@MAX = 3.135 V			-33	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	30			mA	1
		V_{OL} @ MAX = 0.4 V			38	mA	1
Rise Time	t_{r1}	V_{OL} = 0.4 V, V_{OH} = 2.4 V	0.5		2	ns	1
Fall Time	t_{f1}	V_{OH} = 2.4 V, V_{OL} = 0.4 V	0.5		2	ns	1
Skew	t_{sk1}	V_T = 1.5 V			500	ps	1
Duty Cycle	d_{t1}	V_T = 1.5 V	45		55	%	1
Jitter	$t_{jcyc-cyc}$	V_T = 1.5 V			1000	ps	1

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 22Ω (Rs is used in USB48MHz test only)

[1]Guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF is at 14.31818MHz

Electrical Characteristics - Differential Jitter Parameters

PARAMETER	Symbol	Conditions	Min	TYP	Max	Units	Notes
Jitter, Phase	$t_{jphasePLL}$	PCIe Gen 1			86	ps (p-p)	1,2
	$t_{jphaseLo}$	PCIe Gen 2 10kHz < f < 1.5MHz			3	ps (RMS)	1,2
	$t_{jphaseHigh}$	PCIe Gen 2 1.5MHz < f < Nyquist (50MHz)			3.1	ps (RMS)	1,2
	$t_{jphFBD1\_3.2G}$	FBD1 3.2/4G 11MHz to 33MHz			3	ps (RMS)	1,2
	$t_{jphFBD1\_4.0G}$	FBD1 4.8G 11MHz to 33MHz			2.5	ps (RMS)	1,2

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%

[1]Guaranteed by design and characterization, not 100% tested in production.

[2]See http://www.pcisig.com for compelte specs

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General SMBus serial interface information for the ICS932S422C

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will ***acknowledge***
- Controller (host) sends the begining byte location = N
- ICS clock will ***acknowledge***
- Controller (host) sends the data byte count = X
- ICS clock will ***acknowledge***
- Controller (host) starts sending ***Byte N through Byte N + X -1***
  (see Note 2)
- ICS clock will ***acknowledge*** each byte ***one at a time***
- Controller (host) sends a Stop bit

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will ***acknowledge***
- Controller (host) sends the begining byte location = N
- ICS clock will ***acknowledge***
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address D3 (H)
- ICS clock will ***acknowledge***
- ICS clock will send the data byte count = X
- ICS clock sends ***Byte N + X -1***
- ICS clock sends ***Byte 0 through byte X (if X(H) was written to byte 8)***.
- Controller (host) will need to acknowledge each byte
- Controllor (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Write Operation

Controller (Host)			ICS (Slave/Receiver)
T	starT bit		
Slave Address D2(H)			
WR	WRite		
			ACK
Beginning Byte = N			
			ACK
Data Byte Count = X			
			ACK
Beginning Byte N		X Byte	
			ACK
◇			
◇			◇
◇			◇
			◇
Byte N + X - 1			
			ACK
P	stoP bit		

Index Block Read Operation

Controller (Host)		ICS (Slave/Receiver)	
T	starT bit		
Slave Address D2(H)			
WR	WRite		
		ACK	
Beginning Byte = N			
		ACK	
RT	Repeat starT		
Slave Address D3(H)			
RD	ReaD		
		ACK	
		Data Byte Count = X	
ACK			
		X Byte	Beginning Byte N
ACK			
			◇
◇			◇
◇			◇
◇			
			Byte N + X - 1
N	Not acknowledge		
P	stoP bit		

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SMBus Table: SRC Output Enable Register

Byte 0	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	NA	SRCCLK7 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 6	NA	SRCCLK6 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 5	NA	SRCCLK5 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 4	26,27	SRCCLK4 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 3	23,24	SRCCLK3 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 2	21,22	SRCCLK2 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 1	18,19	SRCCLK1 Enable	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 0	32,31	CPUCLK4	Output Enable	RW	Disable-Hi-Z	Enable	1

SMBus Table: CPU, REF and 48 MHz Output Enable Register

Byte 1	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	54	REF1 Enable	Output Enable	RW	Disable-Low	Enable	1
Bit 6	55	REF0 Enable	Output Enable	RW	Disable-Low	Enable	1
Bit 5	36,37	CPUCLK3	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 4	39,40	CPUCLK2	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 3	-	RESERVED					0
Bit 2	42,43	CPUCLK1	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 1	45,46	CPUCLK0	Output Enable	RW	Disable-Hi-Z	Enable	1
Bit 0	CPU, SRC, PCI	Spread Spectrum Enable	Spread Off/On	RW	Spread Off	Spread On	0

SMBus Table: PCI and PCICLK_F Output Enable Register

Byte 2	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	6	PCICLK3	Output Enable	RW	Disable-Low	Enable	1
Bit 6	5	PCICLK2	Output Enable	RW	Disable-Low	Enable	1
Bit 5	4	PCICLK1	Output Enable	RW	Disable-Low	Enable	1
Bit 4	3	PCICLK0	Output Enable	RW	Disable-Low	Enable	1
Bit 3	11	PCICLK_F2 Enable	Output Enable	RW	Disable-Low	Enable	1
Bit 2	10	PCICLK_F1 Enable	Output Enable	RW	Disable-Low	Enable	1
Bit 1	9	PCICLK_F0 Enable	Output Enable	RW	Disable-Low	Enable	1
Bit 0	13	48MHz Enable	Output Enable	RW	Disable-Low	Enable	1

SMBus Table: PCICLK_F and SRC Stop Control Register

Byte 3	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	11	PCICLK_F2 Stop En	Free-Running Control, Default: not affected by PCI/SRC_STOP (Byte 4, bit 5)	RW	Free-Running	Stoppable	1
Bit 6	10	PCICLK_F1 Stop En		RW	Free-Running	Stoppable	1
Bit 5	9	PCICLK_F0 Stop En		RW	Free-Running	Stoppable	1
Bit 4	26,27	SRCCLK4 Stop En		RW	Free-Running	Stoppable	1
Bit 3	23,24	SRCCLK3 Stop En		RW	Free-Running	Stoppable	1
Bit 2	21,22	SRCCLK2 Stop En		RW	Free-Running	Stoppable	1
Bit 1	18,19	SRCCLK1 Stop En		RW	Free-Running	Stoppable	1
Bit 0	-	RESERVED					0

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SMBus Table: CPU and SRC Stop and Power Down Mode Drive Control Register

Byte 4	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	36,37	CPUCLK3 PD Drive	Drive Mode in PD	RW	Driven	Hi-Z	0
Bit 6	39,40	CPUCLK2 PD Drive	Drive Mode in PD	RW	Driven	Hi-Z	0
Bit 5	42,43	CPUCLK1 PD Drive	Drive mode in PD	RW	Driven	Hi-Z	0
Bit 4	45,46	CPUCLK0 PD Drive	Drive mode in PD	RW	Driven	Hi-Z	0
Bit 3	-	RESERVED					0
Bit 2	-	RESERVED					0
Bit 1	-	RESERVED					0
Bit 0	-	RESERVED					0

SMBus Table: Output and Spread Spectrum Control Register

Byte 5	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	32,31	CPUCLK4 PD Drive	Drive Mode in PD	RW	Driven	Hi-Z	0
Bit 6	SRC	SRC Stop Drive Mode	Driven in STOP	RW	Driven	Hi-Z	0
Bit 5	SRC	SRC PD Drive Mode	Driven in PD	RW	Driven	Hi-Z	0
Bit 4	-	RESERVED					0
Bit 3	-	RESERVED					0
Bit 2	-	RESERVED					0
Bit 1	-	RESERVED					0
Bit 0	-	RESERVED					0

SMBus Table: Device ID Register

Byte 6	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	Test Mode Selection	Test Mode Selection	RW	Hi-Z	REF/N	0
Bit 6	-	Test Clock Mode Entry	Test Mode	RW	Disable	Enable	0
Bit 5	-	RESERVED					0
Bit 4	54,55	REF Drive Strength	1X or 2X	RW	1X	2X	1
Bit 3	PCI, SRC	PCI_STOP Control	Stop non-free running PC and SRC clocks.	RW	Stop	Run	1
Bit 2	-	FS_C	FS_C readback	R	See 932S422 Functionality Table		Latch
Bit 1	-	FS_B	FS_B readback	R			Latch
Bit 0	-	FS_A	FS_A readback	R			Latch

SMBus Table: Vendor & Revision ID Register

Byte 7	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	RID3	REVISION ID	R	-	-	0
Bit 6	-	RID2		R	-	-	0
Bit 5	-	RID1		R	-	-	1
Bit 4	-	RID0		R	-	-	0
Bit 3	-	VID3	VENDOR ID	R	-	-	0
Bit 2	-	VID2		R	-	-	0
Bit 1	-	VID1		R	-	-	0
Bit 0	-	VID0		R	-	-	1

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SMBus Table: Byte Count Register

Byte 8	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	BC7	Byte Count Programming b(7:0)	RW	Writing to this register will configure how many bytes will be read back, default is 8 bytes. (0 to 7)		0
Bit 6	-	BC6		RW			0
Bit 5	-	BC5		RW			0
Bit 4	-	BC4		RW			0
Bit 3	-	BC3		RW			1
Bit 2	-	BC2		RW			0
Bit 1	-	BC1		RW			0
Bit 0	-	BC0		RW			0

SMBus Table: Device ID Register

Byte 9	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7		DID7	Device ID (0C hex)	R	-	-	0
Bit 6		DID6		R	-	-	0
Bit 5		DID5		R	-	-	0
Bit 4		DID4		R	-	-	0
Bit 3		DID3		R	-	-	1
Bit 2		DID2		R	-	-	1
Bit 1		DID1		R	-	-	0
Bit 0		DID0		R	-	-	0

SMBus Table: M/N Programming & Control Register

Byte 10	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	M/N_EN	CPU and SRC M/N Programming	RW	Disable	Enable	0
Bit 6	-	RESERVED					0
Bit 5	CPU	Spread Spectrum Enable	Spread Off/On	RW	Spread Off	Spread On	0
Bit 4	SRC	Spread Spectrum Enable	Spread Off/On	RW	Spread Off	Spread On	0
Bit 3	SRC, PCI	SRC Alternate Frequency (96% of Nominal)	Set SRC = 96 MHz and PCI = 32 MHz Only active if Byte 10, bit 2 = 1	RW	Normal	Alternate Frequency	0
Bit 2	CPU	CPU Alternate Frequency (96% of Nominal) Only active if latched frequency is 166 MHz or 333 MHz.	Set alternate CPU frequency: 166 MHz to 160 MHz 333 MHz to 320 MHz	RW	Normal	Alternate Frequency	0
Bit 1	54	REF1 Drive Strength	1X or 2X	RW	See REF Drive Strength Functionality Table		1
Bit 0	55	REF0 Drive Strength	1X or 2X	RW			1

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SMBus Table: CPU Frequency Control Register

Byte 11	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	CPU N Div8	N Divider Prog bit 8	RW	The decimal representation of M and N Divider in Byte 11 and 12 will configure the CPU VCO frequency. Default at power up = latch-in or Byte 0 Rom table. VCO Frequency = 14.318 x [NDiv(9:0)+8] / [MDiv(5:0)+2]		X
Bit 6	-	CPU N Div9	N Divider Prog bit 9	RW			X
Bit 5	-	CPU M Div5	M Divider Programming bit (5:0)	RW			X
Bit 4	-	CPU M Div4		RW			X
Bit 3	-	CPU M Div3		RW			X
Bit 2	-	CPU M Div2		RW			X
Bit 1	-	CPU M Div1		RW			X
Bit 0	-	CPU M Div0		RW			X

SMBus Table: CPU Frequency Control Register

Byte 12	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	CPU N Div7	N Divider Programming Byte12 bit(7:0) and Byte11 bit(7:6)	RW	The decimal representation of M and N Divider in Byte 11 and 12 will configure the CPU VCO frequency. Default at power up = latch-in or Byte 0 Rom table. VCO Frequency = 14.318 x [NDiv(9:0)+8] / [MDiv(5:0)+2]		X
Bit 6	-	CPU N Div6		RW			X
Bit 5	-	CPU N Div5		RW			X
Bit 4	-	CPU N Div4		RW			X
Bit 3	-	CPU N Div3		RW			X
Bit 2	-	CPU N Div2		RW			X
Bit 1	-	CPU N Div1		RW			X
Bit 0	-	CPU N Div0		RW			X

SMBus Table: CPU Spread Spectrum Control Register

Byte 13	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	CPU SSP7	Spread Spectrum Programming bit(7:0)	RW	These Spread Spectrum bits in Byte 13 and 14 will program the spread pecentage of CPU		X
Bit 6	-	CPU SSP6		RW			X
Bit 5	-	CPU SSP5		RW			X
Bit 4	-	CPU SSP4		RW			X
Bit 3	-	CPU SSP3		RW			X
Bit 2	-	CPU SSP2		RW			X
Bit 1	-	CPU SSP1		RW			X
Bit 0	-	CPU SSP0		RW			X

SMBus Table: CPU Spread Spectrum Control Register

Byte 14	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	Reserved					0
Bit 6	-	CPU SSP14	Spread Spectrum Programming bit(14:8)	RW	These Spread Spectrum bits in Byte 13 and 14 will program the spread pecentage of CPU		X
Bit 5	-	CPU SSP13		RW			X
Bit 4	-	CPU SSP12		RW			X
Bit 3	-	CPU SSP11		RW			X
Bit 2	-	CPU SSP10		RW			X
Bit 1	-	CPU SSP9		RW			X
Bit 0	-	CPU SSP8		RW			X

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SMBus Table: SRC Frequency Control Register

Byte 15	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	SRC N Div8	N Divider Prog bit 8	RW	The decimal representation of M and N Divider in Byte 15 and 16 will configure the SRC VCO frequency. Default at power up = latch-in or Byte 0 Rom table. VCO Frequency = 14.318 x [NDiv(9:0)+8] / [MDiv(5:0)+2]		X
Bit 6	-	SRC N Div9	N Divider Prog bit 9	RW			X
Bit 5	-	SRC M Div5	M Divider Programming bits	RW			X
Bit 4	-	SRC M Div4		RW			X
Bit 3	-	SRC M Div3		RW			X
Bit 2	-	SRC M Div2		RW			X
Bit 1	-	SRC M Div1		RW			X
Bit 0	-	SRC M Div0		RW			X

SMBus Table: SRC Frequency Control Register

Byte 16	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	SRC N Div7	N Divider Programming b(7:0)	RW	The decimal representation of M and N Divider in Byte 15 and 16 will configure the SRC VCO frequency. Default at power up = latch-in or Byte 0 Rom table. VCO Frequency = 14.318 x [NDiv(9:0)+8] / [MDiv(5:0)+2]		X
Bit 6	-	SRC N Div6		RW			X
Bit 5	-	SRC N Div5		RW			X
Bit 4	-	SRC N Div4		RW			X
Bit 3	-	SRC N Div3		RW			X
Bit 2	-	SRC N Div2		RW			X
Bit 1	-	SRC N Div1		RW			X
Bit 0	-	SRC N Div0		RW			X

SMBus Table: SRC Spread Spectrum Control Register

Byte 17	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	SRC SSP7	Spread Spectrum Programming b(7:0)	RW	These Spread Spectrum bits in Byte 17 and 18 will program the spread pecentage of SRC		X
Bit 6	-	SRC SSP6		RW			X
Bit 5	-	SRC SSP5		RW			X
Bit 4	-	SRC SSP4		RW			X
Bit 3	-	SRC SSP3		RW			X
Bit 2	-	SRC SSP2		RW			X
Bit 1	-	SRC SSP1		RW			X
Bit 0	-	SRC SSP0		RW			X

SMBus Table: SRC Spread Spectrum Control Register

Byte 18	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	Reserved	Reserved	R	-	-	0
Bit 6	-	SRC SSP14	Spread Spectrum Programming b(14:8)	RW	These Spread Spectrum bits in Byte 17 and 18 will program the spread pecentage of SRC		X
Bit 5	-	SRC SSP13		RW			X
Bit 4	-	SRC SSP12		RW			X
Bit 3	-	SRC SSP11		RW			X
Bit 2	-	SRC SSP10		RW			X
Bit 1	-	SRC SSP9		RW			X
Bit 0	-	SRC SSP8		RW			X

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SMBus Table: CPU Programmable Output Divider Register

Byte 19	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	CPUDiv3	CPU Divider Ratio Programming Bits	RW	See CPU, SRC and PCI Divider Ratios Table		X
Bit 6	-	CPUDiv2		RW			X
Bit 5	-	CPUDiv1		RW			X
Bit 4	-	CPUDiv0		RW			X
Bit 3		RESERVED					X
Bit 2		RESERVED					X
Bit 1		RESERVED					X
Bit 0		RESERVED					X

SMBus Table: SRC and PCI Programmable Output Divider Register

Byte 20	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	PCIDiv3	PCI Divider Ratio Programming Bits	RW	See CPU, SRC and PCI Divider Ratios Table		X
Bit 6	-	PCIDiv2		RW			X
Bit 5	-	PCIDiv1		RW			X
Bit 4	-	PCIDiv0		RW			X
Bit 3	-	SRC_Div3	SRC_ Divider Ratio Programming Bits	RW	See CPU, SRC and PCI Divider Ratios Table		X
Bit 2	-	SRC_Div2		RW			X
Bit 1	-	SRC_Div1		RW			X
Bit 0	-	SRC_Div0		RW			X

SMBusTable: Test Byte Register

Byte 21	Test	Test Function	Type	Test Result	PWD
Bit 7	-	ICS ONLY TEST	RW	Reserved	0
Bit 6	-	ICS ONLY TEST	RW	Reserved	0
Bit 5	-	ICS ONLY TEST	RW	Reserved	0
Bit 4	-	ICS ONLY TEST	RW	Reserved	0
Bit 3	-	ICS ONLY TEST	RW	Reserved	0
Bit 2	-	ICS ONLY TEST	RW	Reserved	0
Bit 1	-	ICS ONLY TEST	RW	Reserved	0
Bit 0	-	ICS ONLY TEST	RW	Reserved	0

Note: Do NOT write to Bit 21. Erratic device operation will result!

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PD, Power Down

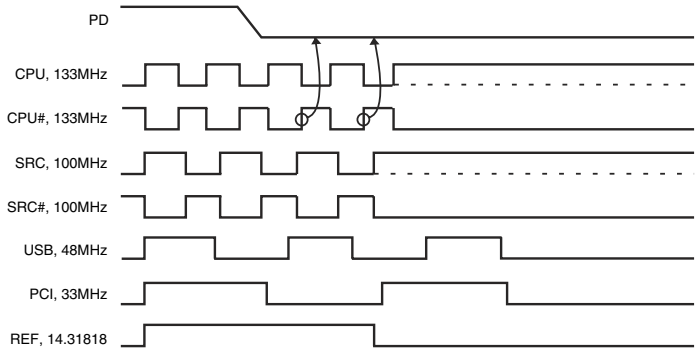
PD is an asynchronous active high input used to shut off all clocks cleanly prior to system power down.
When PD is asserted, all clocks will be driven low before turning off the VCO. All clocks will start without glitches when PD is

PD	CPU	CPU #	SRC	SRC#	PCIF/PCI	USB	REF	Note
1	Normal	Normal	Normal	Normal	33MHz	48MHz	14.318MHz	1
0	Iref * 2 or Float	Float	Iref * 2 or Float	Float	Low	Low	Low	1

Notes:
1. Refer to SMBus Byte 4 for additional information.

PD Assertion

PD should be sampled low by 2 consecutive CPU# rising edges before stopping clocks. All single ended clocks will be held low on their next high to low transition.
All differential clocks will be held high on the next high to low transition of the complimentary clock. If the control register determining to drive mode is set to 'tri-state', the differential pair will be stopped in tri-state mode, undriven.
When the drive mode corresponding to the CPU or SRC clock of interest is set to '0' the true clock will be driven high at 2 x Iref and the complementary clock will be tristated. If the control register is programmed to '1' both clocks will be tristated.
See SMBus Byte 4 for additional information.



CPU, SRC and PCI Divider Ratios

	Div(3:0)	Divider
0	0000	2
1	0001	3
2	0010	5
3	0011	15
4	0100	4
5	0101	6
6	0110	10
7	0111	30
8	1000	8
9	1001	12
10	1010	20
11	1011	60
12	1100	16
13	1101	24
14	1110	40
15	1111	120

REF Drive Strength Functionality

Byte6, bit 4	Byte 10, bit 1	Byte 10, bit 0	REF1	REF0
0	X	X	1x	1x
1	0	0	1x	1x
1	0	1	1x	2x
1	1	0	2x	1x
1	**1**	**1**	**2x**	**2x**

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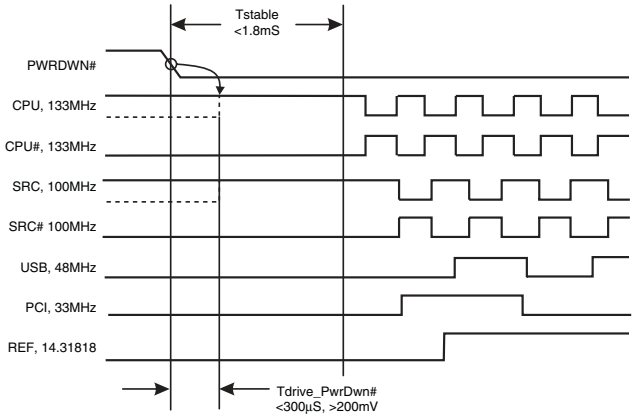
PD De-assertion

The time from the de-assertion of PD or until power supply ramps to get stable clocks will be less than 1.8ms. If the drive mode control bit for PD tristate is programmed to '1' the stopped differential pair must first be driven high to a minimum of 200mV in less than 300µs of PD deassertion.



Test Clarification Table

Comments	HW		SW		
	FSLC/TEST_SEL HW PIN	FSLB/TEST_MODE HW PIN	TEST ENTRY BIT B6b6	REF/N or HI-Z B6b7	OUTPUT
	0	X	0	X	NORMAL
Power-up w/ TEST_SEL = 1 to enter test mode Cycle power to disable test mode FSLC./TEST_SEL -->3-level latched input If power-up w/ V>2.0V (-0.3V) then use TEST_SEL If power-up w/ V<2.0V (-0.3V) then use FSLC FSLB/TEST_MODE -->low Vth input TEST_MODE is a real time input.	1	0	X	0	HI-Z
	1	0	X	1	REF/N
	1	1	X	0	REF/N
	1	1	X	1	REF/N
If TEST_SEL HW pin is 0 during power-up, test mode can be invoked through B6b6. If test mode is invoked by B6b6, only B6b7 is used to select HI-Z or REF/N FSLB/TEST_Mode pin is not used. Cycle power to disable test mode, one shot control	0	X	1	0	HI-Z
	0	X	1	1	REF/N
B6b6: 1= ENTER TEST MODE, Default = 0 (NORMAL OPERATION)					
B6b7: 1= REF/N, Default = 0 (HI-Z)					

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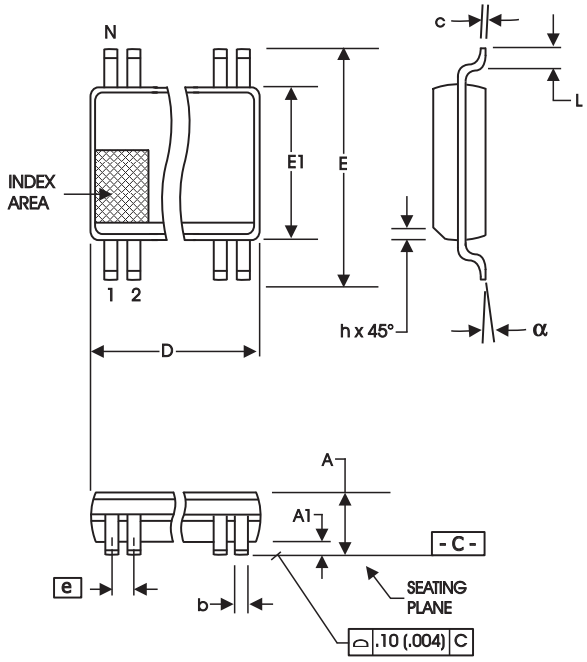

56-Lead, 300 mil Body, 25 mil, SSOP

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	2.41	2.80	.095	.110
A1	0.20	0.40	.008	.016
b	0.20	0.34	.008	.0135
c	0.13	0.25	.005	.010
D	SEE VARIATIONS		SEE VARIATIONS	
E	10.03	10.68	.395	.420
E1	7.40	7.60	.291	.299
e	0.635 BASIC		0.025 BASIC	
h	0.38	0.64	.015	.025
L	0.50	1.02	.020	.040
N	SEE VARIATIONS		SEE VARIATIONS	
a	0°	8°	0°	8°

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
56	18.31	18.55	.720	.730

Reference Doc.: JEDEC Publication 95, MO-118

10-0034

Ordering Information

ICS932S422CFLF-T

Example:

ICS XXXX C F LF- T

- **Designation for tape and reel packaging**
- **Annealed Lead Free (optional)**
- **Package Type**
  F = SSOP
- **Revision Designator** (will not correlate with datasheet revision)
- **Device Type**
- **Prefix**
  ICS = Standard Device

1412A—12/10/07

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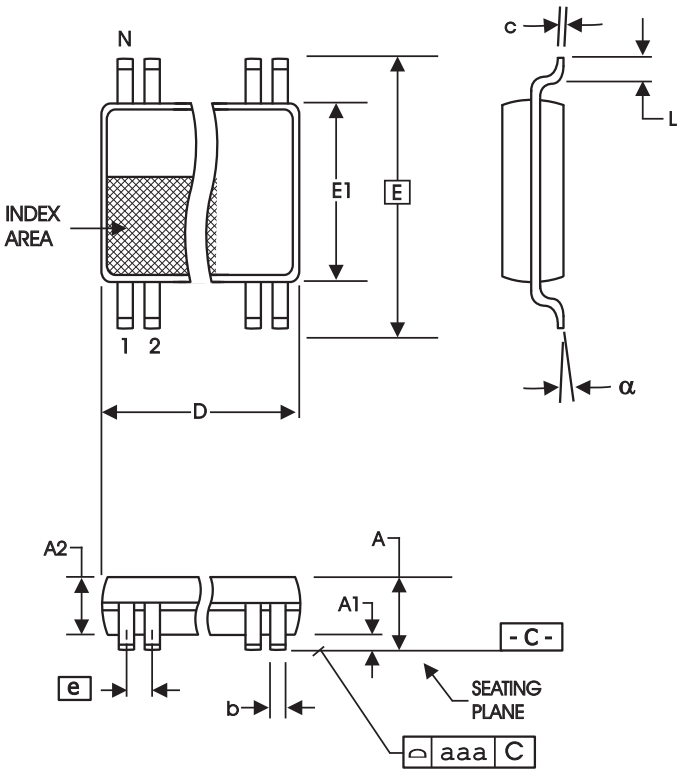

56-Lead 6.10 mm. Body, 0.50 mm. Pitch TSSOP
(240 mil) (20 mil)

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	1.20	--	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.17	0.27	.007	.011
c	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	8.10 BASIC		0.319 BASIC	
E1	6.00	6.20	.236	.244
e	0.50 BASIC		0.020 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
a	0°	8°	0°	8°
aaa	--	0.10	--	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
56	13.90	14.10	.547	.555

Reference Doc.: JEDEC Publication 95, MO-153

10-0039

Ordering Information

ICS932S422CGLF-T

Example:

ICS XXXX C G LF- T

- **Designation for tape and reel packaging**
- **Annealed Lead Free (optional)**
- **Package Type**
  G = TSSOP
- **Revision Designator** (will not correlate with datasheet revision)
- **Device Type**
- **Prefix**
  ICS = Standard Device

1412A—12/10/07

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Revision History

Rev.	Issue Date	Description	Page #
A	12/10/07	Initial Release	-

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